

HRU0103C

Silicon Schottky Barrier Diode for Rectifying

REJ03G0071-0100Z

Rev.1.00

Aug.29.2003

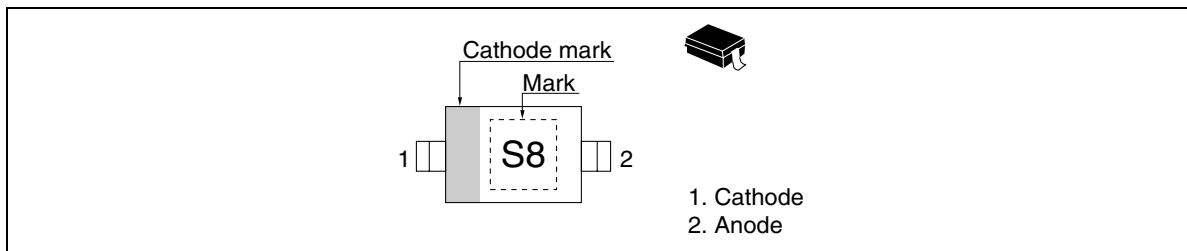
Features

- Low reverse voltage drop and suitable for high efficiency reverse current.
- Ultra small Resin Package (URP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HRU0103C	S8	URP

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Peak reverse voltage	V_{RM}^{*1}	30	V
Reverse voltage	V_R	30	V
Average rectified current	I_O^{*1}	100	mA
Peak forward surge current	I_{FM}	300	mA
Non-Repetitive peak forward surge current	I_{FSM}^{*2}	1	A
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

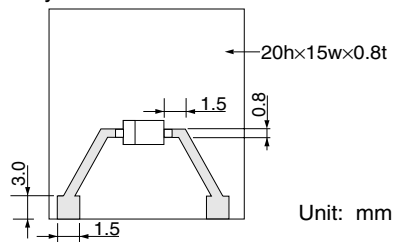
Notes: 1. See from Fig.3 to Fig.5.
 2. 10 ms sine wave 1 pulse.

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Forward voltage	V_{F1}	—	—	0.4	V	$I_F = 10 \text{ mA}$
	V_{F2}	—	—	0.6		$I_F = 100 \text{ mA}$
Reverse current	I_{R1}	—	—	0.1	μA	$V_R = 5 \text{ V}$
	I_{R2}	—	—	0.2		$V_R = 10 \text{ V}$
Capacitance	C	—	—	8.0	pF	$V_R = 0.5 \text{ V}, f = 1 \text{ MHz}$
Thermal resistance	Rth(j-a)	—	600	—	°C/W	Polyimide board ^{*1}

Note: 1. Polyimide board



Main Characteristics

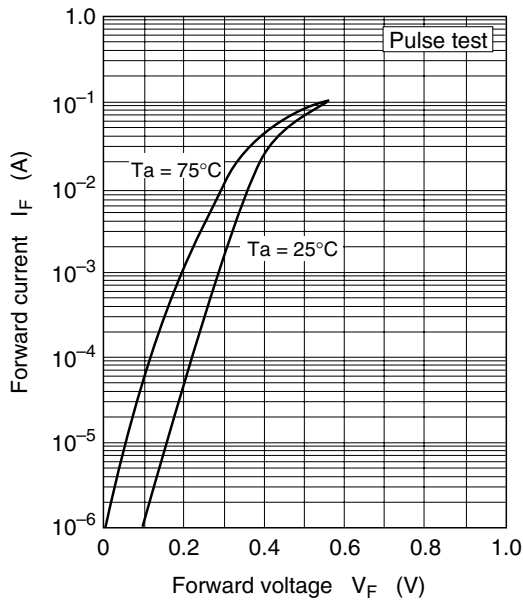


Fig.1 Forward current vs. Forward voltage

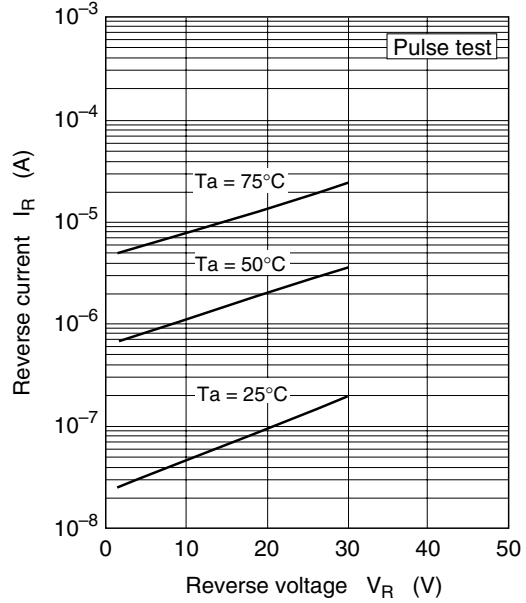


Fig.2 Reverse current vs. Reverse voltage

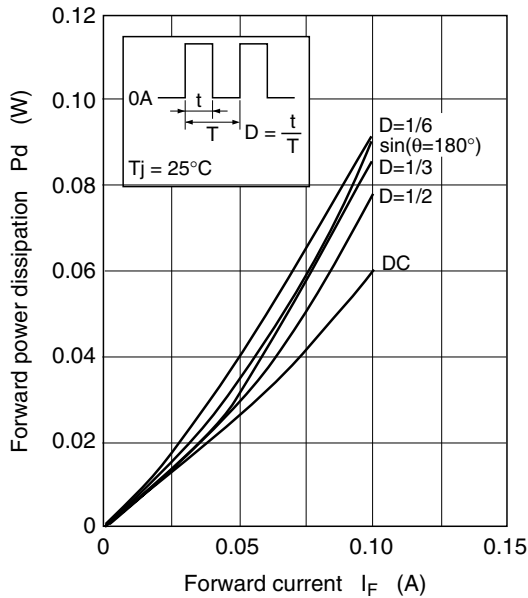


Fig.3. Forward power dissipation vs. Forward current

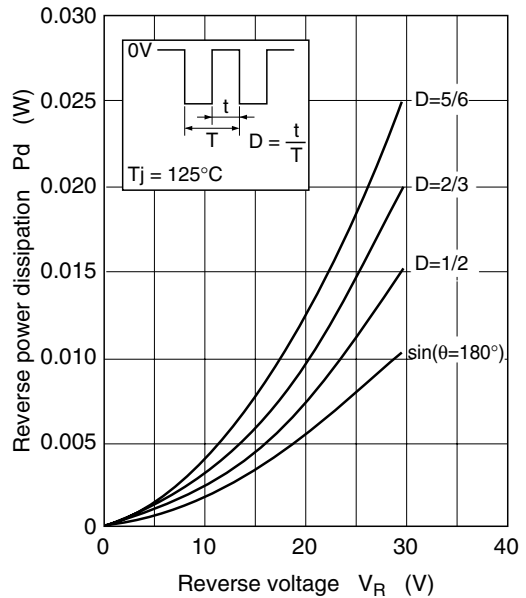


Fig.4. Reverse power dissipation vs. Reverse voltage

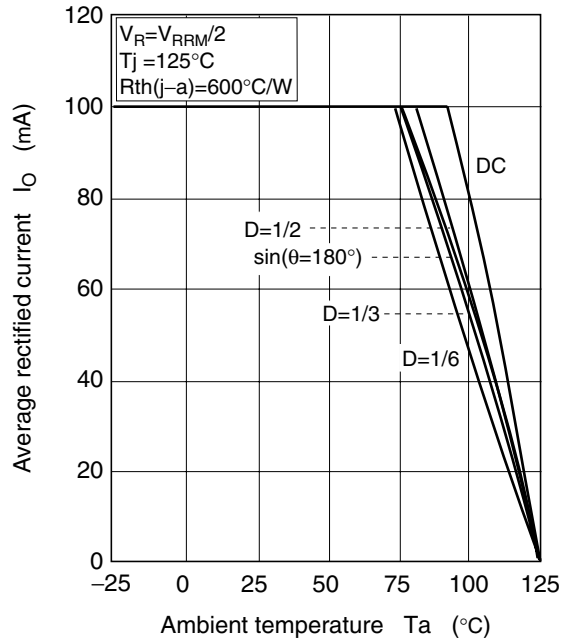
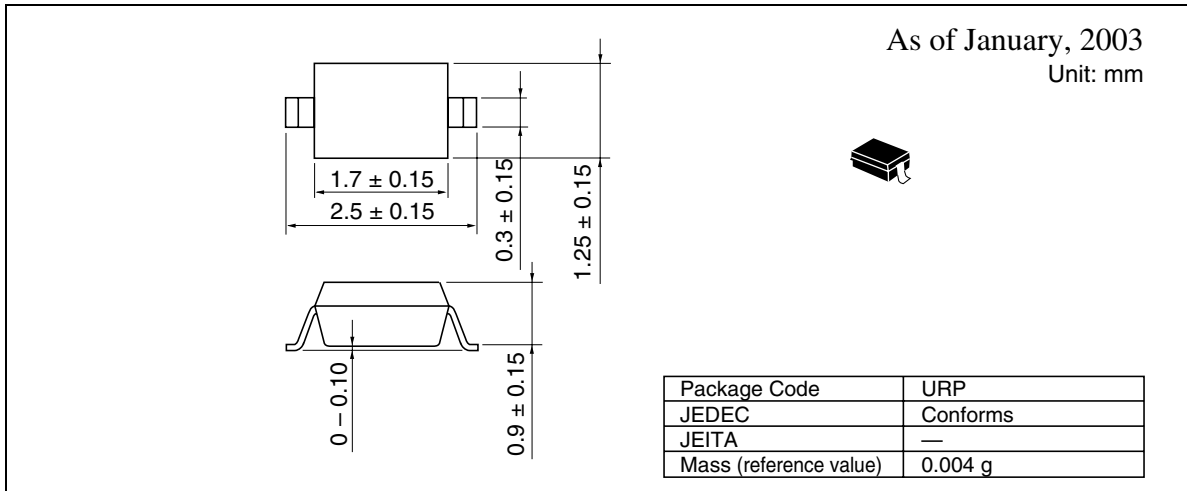


Fig.5 Average rectified current vs. Ambient temperature

Package Dimensions



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Keep safety first in your circuit designs!

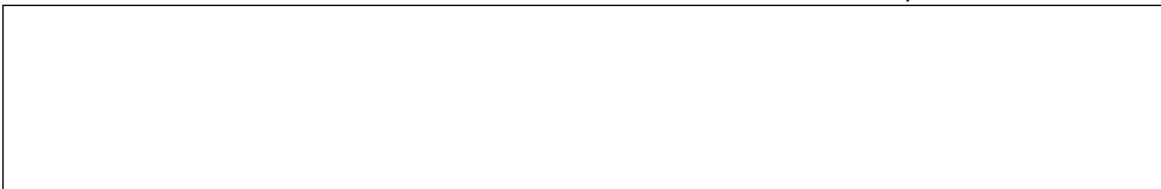
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